AMENDMENT TRANSMITTAL LETTER (Large Entity) Applicant(s): William Palmteer						Docket No. Whitaker No. 17541		
		ling Date 6/8/00		Examiner Quynh-Hnu H. Vu		Group Art Unit 2841		
Invention SOLDER-COATED ARTICLE USEFULE FOR SUBSTRATE ATTACHMENT FEB 1 0 2003								
Transmitted herew The fee has been of		FEB 13 2603 FEB 13 2603	CENED					
CLAIMS AS AMENDED 728								
	CLAIMS REMAINING AFTER AMENDMENT	HIGHEST # PREV. PAID FO		R EXTRA PRESENT	RATE		ADDITIONAL FEE	
TOTAL CLAIMS	26 -	26 =	=	0	x \$18	.00	\$0.00	
INDEP. CLAIMS	6 -	6 =	=	0	x \$84	1.00	\$0.00	
Multiple Dependent Claims (check if applicable)								
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT							\$0.00	0
 No additional fee is required for amendment. □ Please charge Deposit Account No. in the amount of A duplicate copy of this sheet is enclosed. □ A check in the amount of to cover the filing fee is enclosed. ☑ The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. 19-5425 A duplicate copy of this sheet is enclosed. ☑ Any additional filing fees required under 37 C.F.R. 1.16. ☑ Any patent application processing fees under 37 CFR 1.17. Menture Macualla Dated: 2/4/03 								
Theodore Naccard Reg. No. 33,023 Synnestvedt & Le 2600 Aramark To 1101 Market Stre Philadelphia, PA (215) 923-4466	echner LLP ower eet	·		on 2/1/03 first class ma Assistant Co 20231.	ail under 37 (ommissioner	with the C.F.R. 1.8 or for Pate	fee is being depose the U.S. Postal Service and is addressed to ents, Washington, in Correspondence	e as o the
				J Sign	ature of Pers	on Mailing	g Corresponaence	

cc:

Katrina Lynn

Typed or Printed Name of Person Mailing Correspondence

pplication No. 09/590,406

Whitaker Docket No. 17547_{NOLOGY} CENTER 2800

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: William Palmteer

Application No.: 09/590,406

Examiner: Quynh-Nhu H. Vu

Filing Date: June 8, 2000

Group Art: 2841

Title: SOLDER-COATED ARTICLE USEFUL FOR SUBSTRATE ATTACHMENT

CERTIFICATE OF MAILING

I hereby certify that this correspondence, along with any papers indicated as being enclosed, are being deposited as First Class Mail, postage prepaid, in an envelope addressed to: Commissioner for Patents, Washington, D.C. 20231, on February 4, 2003,

Commissioner for Patents Washington, DC 20231

AMENDMENT

Sir:

Responsive to the second Office Action dated November 6, 2002, Applicant amends the application as noted below and respectfully requests favorable reconsideration of this application.

In the Claims

Please amend the claims as noted below.

1. (Twice Amended) A solder-coated article comprising:

a substantially non-deformable dielectric core having a largest dimension ranging from 1 to 1000 microns;